





# JN Semiconductor®

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March 2025

# FDS8958A

# Dual N & P-Channel PowerTrench® MOSFET

### **General Description**

These dual N- and P-Channel enhancement mode power field effect transistors are produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize on-state ressitance and yet maintain superior switching performance.

These devices are well suited for low voltage and battery powered applications where low in-line power loss and fast switching are required.



#### **Features**

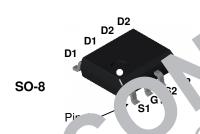
Q1: N-Channel

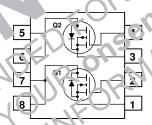
7.0A, 30V 
$$R_{DS(on)} = 0.028\Omega$$
 @  $V_{GS} = 10V$   $R_{DS(on)} = 0.040\Omega$  @  $V - 4.5V$ 

• Q2: P-Channel

$$-5A$$
,  $-30V$   $R_{DS(on)} = 6$   $-22\Omega$  @  $-1$ 

- Fast switching spe
- High, ver 1 hanc g capability in a widely used sunce, unit uckage





# Absolute Max num atings = 25°C unles of the wave noted

Symbol	Parameter	Q1	Q2	Units
Vacq	Prain Jurce Voluage	30	30	V
V <sub>GS</sub>	Gale-Source Voltage	±20	±20	V
I <sub>D</sub>	Drain Current - Continuous (Note 1a)	7	-5	
	- Pu'sed	20	-20	Α
11	Power Dissipation for Dual Operation	2	2	
(N)	Power Dissipation for Single Operation (Note 1a)	1.6	1.6	W
OK	(Note 1c)	0.9	0.9	
Eks	Single Pu'se r valanche Energy (Note 3)	54	13	mJ
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range	-55 to +	-150	°C

### **Thermal Characteristics**

R <sub>θJA</sub>	Thermal Resistance, Junction-to-Ambient	(Note 1a)	78	°C/W
R <sub>eJC</sub>	Thermal Resistance, Junction-to-Case	(Note 1)	40	°C/W

Package Marking and Ordering Information

		<b>y</b>		
Device Marking	Device	Reel Size	Tape width	Quantity
FDS8958A	FDS8958A FDS8958A		12mm	2500 units

$ \begin{array}{ c c c c c c } \hline \Delta T_J & Temperature Coefficient & I_D = -250 \ \mu\text{A}, Referenced to 25^{\circ}\text{C} & Q2 & -23 \\ \hline I_{DSS} & Zero \ Gate \ Voltage \ Drain & V_{DS} = 24 \ V, & V_{GS} = 0 \ V & Q2 & -1 \\ \hline I_{GSSF} & Gate-Body \ Leakage, Forward & V_{GS} = 20 \ V, & V_{DS} = 0 \ V & All & 100 & r \\ \hline I_{GSSR} & Gate-Body \ Leakage, Reverse & V_{GS} = -20 \ V, & V_{DS} = 0 \ V & All & -100 & r \\ \hline \hline On \ Characteristics & (Note 2) & V_{DS} = V_{GS}, & I_D = 250 \ \mu\text{A} & Q1 & 1 & 1.9 & 3 \\ \hline V_{GS(th)} & Gate \ Threshold \ Voltage & V_{DS} = V_{GS}, & I_D = 250 \ \mu\text{A} & Q2 & -1 & 1.7 & -3 \\ \hline \Delta V_{GS(th)} & Gate \ Threshold \ Voltage & V_{DS} = V_{GS}, & I_D = 250 \ \mu\text{A} & Q2 & -1 & 1.7 & -3 \\ \hline \Delta V_{GS(th)} & Gate \ Threshold \ Voltage & I_D = 250 \ \mu\text{A}, \ Referenced to 25^{\circ}\text{C} & Q2 & -1 & 1.7 & -3 \\ \hline \Delta V_{GS(th)} & Gate \ Threshold \ Voltage & I_D = -250 \ \mu\text{A}, \ Referenced to 25^{\circ}\text{C} & Q2 & -1 & 1.7 & -3 \\ \hline A_{DS(on)} & Static \ Drain-Source & V_{GS} = 10 \ V, & I_D = 7 \ A, \ T_J = 125^{\circ}\text{C} & 27 & 42 \\ \hline V_{GS} = 10 \ V, & I_D = 7 \ A, \ T_J = 125^{\circ}\text{C} & 42 & 52 \\ \hline V_{GS} = -10 \ V, & I_D = -5 \ A, \ T_J = 125^{\circ}\text{C} & 42 & 52 \\ \hline V_{GS} = -10 \ V, & I_D = -5 \ A, \ T_J = 125^{\circ}\text{C} & 42 & 52 \\ \hline V_{GS} = -10 \ V, & V_{DS} = V & Q2 & 20 \\ \hline D_{D(on)} & On-State \ Drain \ Current & V_{GS} = 10 \ V, & V_{DS} = V & Q2 & 20 \\ \hline D_{PS} & Forward \ Transconductance & V_{DS} = 5 \ V, & V_D = 7 \ A, \ T_J = 125^{\circ}\text{C} & 7 \ A, \ T_J =$	$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	Symbol	Parameter	Test	Conditions	Туре	Min	Тур	Max	Units
		Off Char	racteristics							•
			Drain-Source Breakdown		•					V
	$ \begin{array}{ c c c c c } \hline \Delta T_J & Temperature Coefficient & I_D = -250  \mu A,  Referenced to 25^\circ C & Q2 & -23 \\ \hline I_{DSS} & Zero  Gate  Voltage  Drain & V_{DS} = 24  V, & V_{GS} = 0  V & Q1 & 1 & 1 & \mu \\ \hline Current & V_{DS} = -24  V, & V_{GS} = 0  V & Q2 & -1 & 1 & \mu \\ \hline I_{GSSF} & Gate-Body  Leakage,  Forward & V_{GS} = 20  V, & V_{DS} = 0  V & All & 1000 & n \\ \hline I_{GSSR} & Gate-Body  Leakage,  Reverse & V_{GS} = -20  V, & V_{DS} = 0  V & All & -1000 & n \\ \hline \hline \textbf{On Characteristics} & \textbf{(Note 2)} & & & & & & & & & & & & & & & & & & &$	ARVnes					-30	25		mV/°C
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$									III V / C
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	I <sub>DSS</sub>		$V_{DS} = 24 \text{ V},$	$V_{GS} = 0 V$					μΑ
$ \begin{array}{ c c c c c } \hline \textbf{On Characteristics} & \textbf{(Note 2)} \\ \hline \textbf{V}_{GS(th)} & \textbf{Gate Threshold Voltage} & \textbf{V}_{DS} = \textbf{V}_{GS}, & \textbf{I}_{D} = 250~\mu\text{A} & \textbf{Q1} & 1 & 1.9 & 3 \\ \hline \textbf{V}_{DS} = \textbf{V}_{GS}, & \textbf{I}_{D} = -250~\mu\text{A} & \textbf{Q2} & -1 & 1.7 & -3 \\ \hline \textbf{\Delta}\underline{\textbf{V}}_{GS(th)} & \textbf{Gate Threshold Voltage} & \textbf{I}_{D} = 250~\mu\text{A}, & \textbf{Referenced to 25°C} & \textbf{Q1} & -4.5 & -4.5 \\ \hline \textbf{AT}_{J} & \textbf{Temperature Coefficient} & \textbf{I}_{D} = 250~\mu\text{A}, & \textbf{Referenced to 25°C} & \textbf{Q2} & -4.5 & -4.5 \\ \hline \textbf{R}_{DS(on)} & \textbf{Static Drain-Source} & \textbf{V}_{GS} = 10~\textbf{V}, & \textbf{I}_{D} = 7~\textbf{A} & \textbf{Q1} & 19 & 20 & -4.5 \\ \hline \textbf{V}_{GS} = 4.5~\textbf{V}, & \textbf{I}_{D} = 6~\textbf{A} & -4.5 & -4.5 & -4.5 \\ \hline \textbf{V}_{GS} = -10~\textbf{V}, & \textbf{I}_{D} = -5~\textbf{A}, & \textbf{T}_{D} = 125°C & -4.2 & -4.2 & -4.2 \\ \hline \textbf{V}_{CS} = -10~\textbf{V}, & \textbf{I}_{D} = -5~\textbf{A}, & \textbf{T}_{D} = 125°C & -4.2 & -4.2 & -4.2 \\ \hline \textbf{V}_{CS} = -10~\textbf{V}, & \textbf{I}_{D} = -5~\textbf{A}, & \textbf{T}_{D} = 125°C & -4.2 & -4.2 & -4.2 \\ \hline \textbf{V}_{CS} = -10~\textbf{V}, & \textbf{I}_{D} = -5~\textbf{A}, & \textbf{T}_{D} = 125°C & -4.2 & -4.2 & -4.2 \\ \hline \textbf{V}_{CS} = -10~\textbf{V}, & \textbf{I}_{D} = -5~\textbf{A}, & \textbf{T}_{D} = 125°C & -4.2 & -4.2 & -4.2 \\ \hline \textbf{V}_{CS} = -10~\textbf{V}, & \textbf{I}_{D} = -5~\textbf{A}, & \textbf{T}_{D} = 125°C & -4.2 & -4.2 & -4.2 \\ \hline \textbf{V}_{CS} = -10~\textbf{V}, & \textbf{V}_{DS} = \textbf{V} & -4.2 & -4.2 & -4.2 \\ \hline \textbf{Q}_{CS} = -10~\textbf{V}, & \textbf{V}_{DS} = \textbf{V} & -4.2 & -4.2 & -4.2 \\ \hline \textbf{Q}_{CS} = -10~\textbf{V}, & \textbf{V}_{DS} = \textbf{V} & -4.2 & -4.2 & -4.2 \\ \hline \textbf{Q}_{CS} = -10~\textbf{V}, & \textbf{V}_{DS} = \textbf{V} & -4.2 & -4.2 & -4.2 \\ \hline \textbf{Q}_{CS} = -10~\textbf{V}, & \textbf{V}_{DS} = \textbf{V} & -4.2 & -4.2 & -4.2 \\ \hline \textbf{Q}_{CS} = -10~\textbf{V}, & \textbf{V}_{DS} = \textbf{V} & -4.2 & -4.2 & -4.2 \\ \hline \textbf{Q}_{CS} = -10~\textbf{V}, & \textbf{V}_{DS} = \textbf{V} & -4.2 & -4.2 & -4.2 \\ \hline \textbf{Q}_{CS} = -10~\textbf{V}, & \textbf{V}_{DS} = \textbf{V} & -4.2 & -4.2 \\ \hline \textbf{Q}_{CS} = -10~\textbf{V}, & \textbf{V}_{DS} = \textbf{V} & -4.2 & -4.2 \\ \hline \textbf{Q}_{CS} = -10~\textbf{V}, & \textbf{V}_{DS} = \textbf{V} & -4.2 & -4.2 \\ \hline \textbf{Q}_{CS} = -10~\textbf{V}, & \textbf{V}_{DS} = \textbf{V} & -4.2 & -4.2 \\ \hline \textbf{Q}_{CS} = -10~\textbf{V}, & \textbf{V}_{DS} = \textbf{V} & -4.2 & -4.2 \\ \hline \textbf{Q}_{CS} = -10~\textbf{V}, & \textbf{V}_{DS} = \textbf{V} & -4.2 & -4.2 \\ \hline \textbf{Q}_{CS} = -10~\textbf{V}, & \textbf{V}_{DS} = \textbf$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	I <sub>GSSF</sub>		$V_{GS} = 20 \text{ V},$	$V_{DS} = 0 \text{ V}$					nA
$ \begin{array}{ c c c c c c } \hline V_{GS(th)} & Gate Threshold Voltage & V_{DS} = V_{GS}, & I_D = 250 \ \mu A & Q1 & 1 & 1.9 & 3 \\ \hline V_{DS} = V_{GS}, & I_D = -250 \ \mu A & Q2 & -1 & 1.7 & -3 \\ \hline \Delta V_{GS(th)} & Gate Threshold Voltage & I_D = 250 \ \mu A, & Referenced to 25°C & Q1 & -4.5 \\ \hline \Delta T_J & Temperature Coefficient & I_D = -250 \ \mu A, & Referenced to 25°C & Q2 & -4.5 \\ \hline R_{DS(on)} & Static Drain-Source & V_{GS} = 10 \ V, & I_D = 7 \ A, & T_J = 125°C & 27 & 42 \\ \hline V_{GS} = 10 \ V, & I_D = 6 \ A & -4.5 & -4.5 \\ \hline V_{GS} = -10 \ V, & I_D = -5 \ A & -5.5 & -5.5 \\ \hline I_{D(on)} & On-State Drain Current & V_{GS} = 10 \ V, & V_{DS} = V & Q2 & -20 \\ \hline S_{FS} & Forward Transconductance & V_{DS} = 5 \ V, & V_D = 7 \ A, & V_D$	$ \begin{array}{ c c c c c c c c } \hline V_{GS(th)} & Gate Threshold Voltage & V_{DS} = V_{GS}, & I_D = 250 \ \mu A & Q1 & 1 & 1.9 & 3 & V_{DS} = V_{GS}, & I_D = -250 \ \mu A & Q2 & -1 & 1.7 & -3 & V_{DS} = V_{DS}, & I_D = -250 \ \mu A & Q2 & -1 & 1.7 & -3 & V_{DS} = V_{DS}, & I_D = -250 \ \mu A & Q2 & -1 & 1.7 & -3 & V_{DS} = -250 \ \mu A & Q2 & -1 & 1.7 & -1.7 & -3 & V_{DS} = -250 \ \mu A & Q2 & -1 & 1.7 & -1.7 & -1.7 & -1.7 \ \mu A & Q2 & -1.7 & -1.7 & -1.7 & -1.7 & -1.7 \ \mu A & Q2 & -1.7 & -1.7 & -1.7 & -1.7 & -1.7 \ \mu A & Q2 & -1.7 & -1.7 & -1.7 & -1.7 & -1.7 \ \mu A & Q2 & -1.7 & -1.7 & -1.7 & -1.7 & -1.7 \ \mu A & Q2 & -1.7 & -1.7 & -1.7 & -1.7 \ \mu A & Q2 & -1.7 & -1.7 & -1.7 & -1.7 \ \mu A & Q2 & -1.7 & -1.7 & -1.7 & -1.7 \ \mu A & Q2 & -1.7 & -1.7 & -1.7 & -1.7 \ \mu A & Q2 & -1.7 & -1.7 & -1.7 & -1.7 \ \mu A & Q2 & -1.7 & -1.7 & -1.7 & -1.7 \ \mu A & Q2 & -1.7 & -1.7 & -1.7 & -1.7 \ \mu A & Q2 & -1.7 & -1.7 & -1.7 & -1.7 \ \mu A & Q2 & -1.7 & -1.7 & -1.7 & -1.7 \ \mu A & Q2 & -1.7 & -1.7 & -1.7 & -1.7 \ \mu A & Q2 & -1.7 & -1.7 & -1.7 \ \mu A & Q2 & -1.7 & -1.7 & -1.7 \ \mu A & Q2 & -1$	I <sub>GSSR</sub>	Gate-Body Leakage, Reverse			All			-100	nA
$ \begin{array}{ c c c c c c } \hline V_{GS(th)} & Gate Threshold Voltage & V_{DS} = V_{GS}, & I_D = 250 \ \mu A & Q1 & 1 & 1.9 & 3 \\ \hline V_{DS} = V_{GS}, & I_D = -250 \ \mu A & Q2 & -1 & 1.7 & -3 \\ \hline \Delta V_{GS(th)} & Gate Threshold Voltage & I_D = 250 \ \mu A, & Referenced to 25°C & Q1 & -4.5 \\ \hline \Delta T_J & Temperature Coefficient & I_D = -250 \ \mu A, & Referenced to 25°C & Q2 & -4.5 \\ \hline R_{DS(on)} & Static Drain-Source & V_{GS} = 10 \ V, & I_D = 7 \ A, & T_J = 125°C & 27 & 42 \\ \hline V_{GS} = 10 \ V, & I_D = 6 \ A & -4.0 \\ \hline V_{GS} = -10 \ V, & I_D = -5 \ A, & T_J = 25°C & 27 & 78 \\ \hline V_{GS} = -10 \ V, & I_D = -5 \ A, & T_J = 25°C & 27 & 78 \\ \hline V_{GS} = -10 \ V, & I_D = -5 \ A, & T_J = 25°C & 27 & 78 \\ \hline V_{GS} = -10 \ V, & I_D = -5 \ A, & T_J = 25°C & 27 & 78 \\ \hline V_{GS} = -10 \ V, & T_J = -5 \ A, & T_J = 25°C & 27 & 78 \\ \hline V_{GS} = -10 \ V, & T_J = -5 \ A, & T_J = 25°C & 27 & 78 \\ \hline V_{GS} = -10 \ V, & T_J = -5 \ A, & T_J = 25°C & 27 & 78 \\ \hline V_{GS} = -10 \ V, & T_J = -5 \ A, & T_J = 25°C & 27 & 78 \\ \hline V_{GS} = -10 \ V, & T_J = -5 \ A, & T_J = 25°C & 27 & 78 \\ \hline V_{GS} = -10 \ V, & T_J = -5 \ A, & T_J = 25°C & 27 & 78 \\ \hline V_{GS} = -10 \ V, & T_J = -5 \ A, & T_J = 25°C & 27 & 78 \\ \hline V_{GS} = -10 \ V, & T_J = -5 \ A, & T_J = 25°C & 27 & 78 \\ \hline V_{GS} = -10 \ V, & T_J = -5 \ A, & T_J = 25°C & 27 & 27 \\ \hline V_{GS} = -10 \ V, & T_J = -5 \ A, & T_J = 25°C & 27 & 27 \\ \hline V_{GS} = -10 \ V, & T_J = -5 \ A, & T_J = 25°C & 27 & 27 \\ \hline V_{GS} = -10 \ V, & T_J = -5 \ A, & T_J = 25°C & 27 & 27 \\ \hline V_{GS} = -10 \ V, & T_J = -5 \ A, & T_J = 25°C & 27 & 27 \\ \hline V_{GS} = -10 \ V, & T_J = -5 \ A, & T_J = 25°C & 27 & 27 \\ \hline V_{GS} = -10 \ V, & T_J = -5 \ A, & T_J = 25°C & 27 & 27 \\ \hline V_{GS} = -10 \ V, & T_J = -5 \ A, & T_J = 25°C & 27 & 27 \\ \hline V_{GS} = -10 \ V, & T_J = -5 \ A, & T_J = 25°C & 27 & 27 \\ \hline V_{GS} = -10 \ V, & T_J = -5 \ A, & T_J = 25°C & 27 & 27 \\ \hline V_{GS} = -10 \ V, & T_J = -5 \ A, & T_J = 25°C & 27 & 27 \\ \hline V_{GS} = -10 \ V, & T_J = -5 \ A, & T_J = -5 \ A$	$ \begin{array}{ c c c c c c c c } \hline V_{GS(th)} & Gate Threshold Voltage & V_{DS} = V_{GS}, & I_D = 250 \ \mu A & Q1 & 1 & 1.9 & 3 & V_{DS} = V_{GS}, & I_D = -250 \ \mu A & Q2 & -1 & 1.7 & -3 & V_{DS} = V_{CS(th)} \\ \hline \Delta V_{DS} = V_{GS}, & I_D = -250 \ \mu A & Q2 & -1 & 1.7 & -3 & V_{DS} = V_{CS(th)} \\ \hline \Delta V_{DS} = V$	On Char	acteristics (Note 2)	-N						ı
	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$			$V_{DS} = V_{GS}$	I <sub>D</sub> = 250 μA		1	1.0	3	V
	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$		0 . 7		$I_D = -250  \mu A$	_	<u>-1</u>		-3	
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$							-4.5		V/°C
$ \begin{array}{ c c c c c c c c c } \hline On-Resistance & V_{GS} = 10 \ V, & I_D = 7 \ A, \ T_J = 125^{\circ}C \\ \hline V_{GS} = 4.5 \ V, & I_D = 6 \ A \\ \hline V_{GS} = -10 \ V, & I_D = -5 \ A \\ \hline V_{GS} = -10 \ V, & I_D = -5 \ A, \ T = 125^{\circ}C \\ \hline V_{GS} = -10 \ V, & I_D = -5 \ A, \ T = 125^{\circ}C \\ \hline V_{GS} = -10 \ V, & I_D = -5 \ A, \ T = 125^{\circ}C \\ \hline V_{GS} = -10 \ V, & I_D = -5 \ A, \ T = 125^{\circ}C \\ \hline V_{GS} = -10 \ V, & I_D = -4 \ A \\ \hline V_{GS} = -10 \ V, & I_D = -4 \ A \\ \hline V_{GS} = -10 \ V, & I_D = -4 \ A \\ \hline V_{GS} = -10 \ V, & I_D = -4 \ A \\ \hline V_{GS} = -10 \ V, & I_D = -7 \ A, \ T = 125^{\circ}C \\ \hline V_{GS} = -10 \ V, & I_D = -7 \ A, \ I_D =$	$ \begin{array}{ c c c c c c c c c } \hline & On-Resistance & V_{GS} = 10 \ V, & I_D = 7 \ A, \ T_J = 125^{\circ}C \\ \hline & V_{GS} = 4.5 \ V, & I_D = 6 \ A \\ \hline & V_{GS} = -10 \ V, & I_D = -5 \ A, \ T_J = 125^{\circ}C \\ \hline & V_{GS} = -10 \ V, & I_D = -5 \ A, \ T_J = 125^{\circ}C \\ \hline & V_{GS} = -10 \ V, & I_D = -5 \ A, \ T_J = 125^{\circ}C \\ \hline & V_{GS} = -10 \ V, & I_D = -5 \ A, \ T_J = 125^{\circ}C \\ \hline & V_{GS} = -10 \ V, & I_D = -5 \ A, \ T_J = 125^{\circ}C \\ \hline & V_{GS} = -10 \ V, & I_D = -5 \ A, \ T_J = 125^{\circ}C \\ \hline & V_{GS} = -10 \ V, & I_D = -5 \ A, \ T_J = 125^{\circ}C \\ \hline & V_{GS} = -10 \ V, & I_D = -5 \ A, \ T_J = 125^{\circ}C \\ \hline & V_{GS} = -10 \ V, & I_D = -5 \ A, \ T_J = 125^{\circ}C \\ \hline & V_{GS} = -10 \ V, & V_{DS} = -10 \$							19	20	mΩ
$\begin{array}{ c c c c c c c c c }\hline & V_{GS} = -10 \text{ V}, & I_D = -5 \text{ A} \\ & V_{GS} = -10 \text{ V}, & I_D = -5 \text{ A}, & T = -25 \text{ C} \\ & V_{GS} = -10 \text{ V}, & I_D = -5 \text{ A}, & T = -25 \text{ C} \\ & V_{GS} = -4.5 \text{ V}, & I_D = -4 \text{ A} \\ & V_{GS} = -4.5 \text{ V}, & I_D = -4 \text{ A} \\ & V_{GS} = -10 \text{ V}, & V_{DS} = -20 \text{ C} \\ & V_{DS} = -10 \text{ V}, & V_{DS} = -20 \text{ C} \\ & V_{DS} =$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	- 1 - /	On-Resistance		= 7 A, T <sub>J</sub> = 125°C				42	N
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$					1 -	7	10		1
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$				$I_D = -5 A$ 5 $\Delta$ T 125°C	5				
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$				I <sub>D</sub> = 4 A					
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	I <sub>D(on)</sub>	On-State Drain Current		70s 5V					Α
Dynamic Characteristics  Ciss Input Capacitance Q. Compared to the compared to	Dynamic Characteristics  Ciss Input Capacitance Q  Cips 15 V v.s = 0 V 1 × 1 CMHz 1 O2   528   p	<b>g</b> FS	Forward Transconductance	$V_{DS} = 5 V$	'p = 7 A	Q1		23		I.
C <sub>iss</sub> Input Capacitance $Q$	C <sub>iss</sub> Input Capacitance Q C1 575 p		01	V <sub>DS</sub> = -\ (,	=-5 A	Q2!	-	10	10	
/ps '5 V v s = 0 V 1 = 10 MHz   O2	(ps 15 V v s = 0 V 1 = 10 MHz			[O		T AV		7E-7E	1//	nE
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	Coss         Output Capacitance         Q1         145         p           Crss         Reverse Transier Capacitance         Discrete Capacitance			15 V. v.s	= 0 V, 1 - 1.0 MHz		. (		Ì	pF
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	Coss	Output Capacitance		Willy 16	Q1 .	1			pF
$R_{\rm G}$ Gate Pesis nee $V_{\rm CS} \sim 15  {\rm mV},  {\rm f} = 1.0  {\rm MHz}$ $\begin{array}{ c c c c c c c c c c c c c c c c c c c$	R <sub>G</sub> Gate Pesis noe V <sub>CS</sub> -15 mV, f - 1.0 MHz Q1 Q1 6.0	C <sub>rss</sub>	Reverse Tr Jie. Capa ance	$j_{S} = -15  \text{V},  \text{V}_{C}$	$_{S} = 0 \text{ V } f = 1.0 \text{ MHz}$	QT	-	65		pF
	CEISEASENTATIVE Q2 6.0 3	R <sub>o</sub>	Gate Resis noe	V - c - 15 mV	f = 10 MHz					Ω
MOI COLINE	O LO LE SENTATIVE		d. cons	3, 1,,		Q2				22
G CK (A)	I CE EASEN'I		SeNot	CO	NE	Q2				
OEVIC PLES		V.								
DEVICEPRES	D. EP.	)	21							
DEVICEPRES	REP									

Symbol	Parameter	Test Conditions	Туре	Min	Тур	Max	Units
Switchir	ng Characteristics	Note 2)					
t <sub>d(on)</sub>	Turn-On Delay Time	Q1 $V_{DD} = 15 \text{ V}, I_{D} = 1 \text{ A},$	Q1 Q2		8 7	16 14	ns
t <sub>r</sub>	Turn-On Rise Time	$V_{GS} = 10V, R_{GEN} = 6 \Omega$	Q1 Q2		5 13	10 24	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	Q2 $V_{DD} = -15 \text{ V}, I_D = -1 \text{ A},$	Q1 Q2		23 14	37 25	ns
t <sub>f</sub>	Turn-Off Fall Time	$V_{GS}$ = -10V, $R_{GEN}$ = 6 $\Omega$	Q1 Q2		3 9	6 17	ns
$Q_g$	Total Gate Charge	Q1 $V_{DS} = 15 \text{ V}, I_D = 7 \text{ A}, V_{GS} = 10 \text{ V}$	Q1 Q2		11.4 9.6	16	nC
$Q_{gs}$	Gate-Source Charge	Q2	Q1 Q2		1.7		пC
$Q_{gd}$	Gate-Drain Charge	$V_{DS} = -15 \text{ V}, I_{D} = -5 \text{ A}, V_{GS} = -10 \text{ V}$	Q1 Q2		2.1		ήC

Is	Maximum Continuous Drain-S	Source Diode Forward Current 1 1.3	4
I <sub>SM</sub>	Maximum Plused Drain-Source	ce Diode Forward Current (Note 2) Q 2 20 A	4
$V_{\text{SD}}$	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_S = 1.3         $	$\overline{\mathcal{I}}$
t <sub>rr</sub>	Diode Reverse Recovery Time	$Q_1$ $I_F = 7 A^{-1} I_F/d_1 = 1 A/\mu s$ $Q_2$ $Q_3$ $Q_4$ $Q_5$ $Q_5$	S
Q <sub>rr</sub>	Diode Reverse Recovery Charge	Q2 I <sub>i</sub>	С

#### Notes:

1.  $R_{aJA}$  is the sum of the junction-to-case and the drain pins.  $R_{aJC}$  is guaranteed by design. Leto-amb the drain pins.  $R_{aJC}$  is guaranteed by design.





b) 12: °/W when mou...ted on a .02 in² pad of 2 oz c op Jer



c) 135 °/W when mounted on a minimum pad.

- hale 1: n letter size paner
- 2. Le Test: Pulse Wid h < 300µs, Duty Circle < 2.0%
- 3. Starting TJ  $\sim 25\,^{\circ}\text{C},\,L=3\text{mH},\,i,\,\varsigma=6\text{A},\,V_{\text{DP}}-3\,^{\circ}\text{V},\,V_{\text{GS}}=10\text{V}$  (Q1).

Star ng  $\Gamma J = 25$  °C, L = 3mH, I<sub>AS</sub> =  $\Sigma$ 4,  $V_{DD}$  = 30V,  $V_{GS}$  = 10V (Q2).

## **Typical Characteristics: Q1 (N-Channel)**

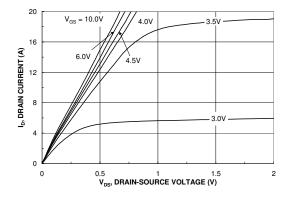


Figure 1. On-Region Characteristics.

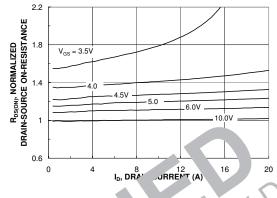
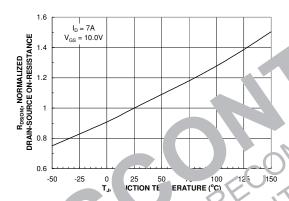


Figure 2. On-Re. tan Vari on with Drain rrent d G oltage.



Figu 3 Pesicance Variation with mperature.

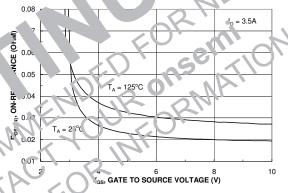


Figure 4. On-Resistance Variation with Gate-to-Source Voltage.

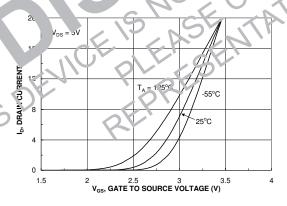


Figure 5. Transfer Characteristics.

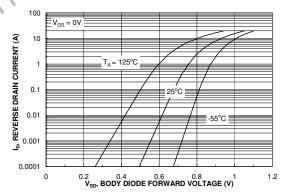
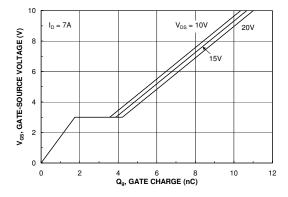


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature.

# Typical Characteristics: Q1 (N-Channel)



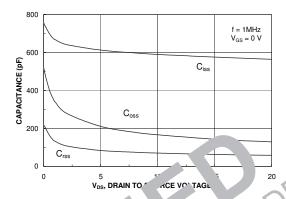
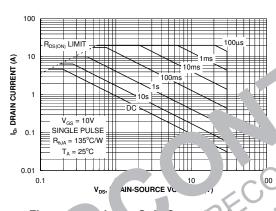


Figure 7. Gate Charge Characteristics.





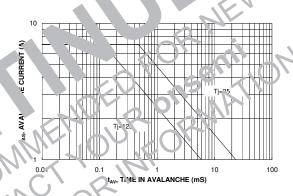


Figure . Iv. axim. 1 Saf Operating Area.

Figure 13. Unclamped Inductive Switching Capability Figure

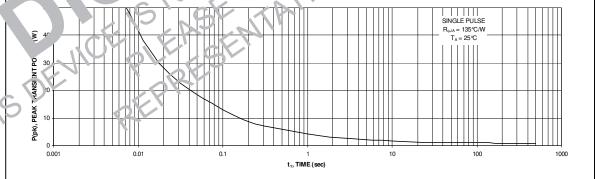


Figure 11. Single Pulse Maximum Power Dissipation.

# **Typical Characteristics: Q2 (P-Channel)**

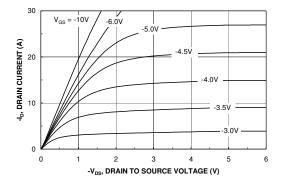


Figure 12. On-Region Characteristics.

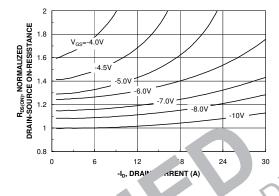
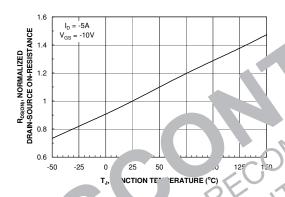


Figure 13. On-Re stal Vari ion with Drain rrent d G oltage.



Figur 14 Researce Variation with mperature.

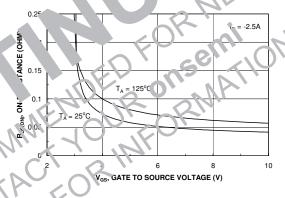


Figure 15. On-Resistance Variation with Gate-to-Source Voltage.

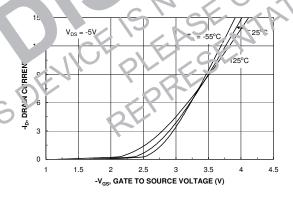


Figure 16. Transfer Characteristics.

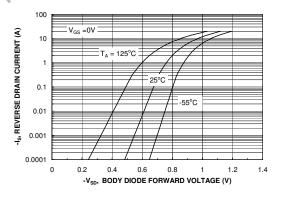
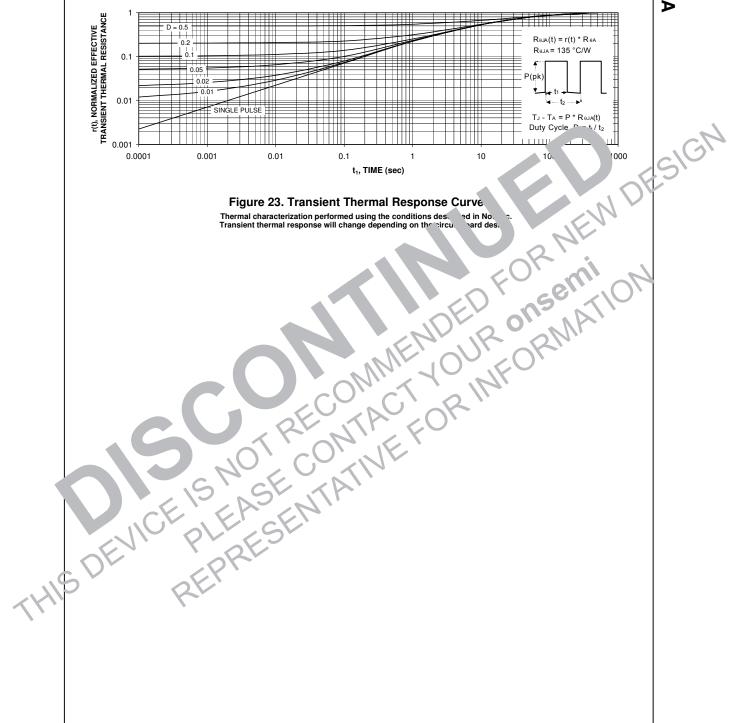


Figure 17. Body Diode Forward Voltage Variation with Source Current and Temperature.

# Typical Characteristics: Q2 (P-Channel)







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